

ROHS COMPLIANT

## N-Channel 40 V (D-S) MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	$R_{DS(on)}\left(\Omega\right)$ $I_{D}\left(A ight)$ $Q_{g}$		
40	0.0010 at V <sub>GS</sub> = 10 V	280	240 nC	
	0.0012 at V <sub>GS</sub> = 4.5 V	250	240110	



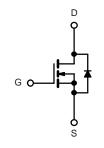


### FEATURES

- TrenchFET<sup>®</sup> Power MOSFET
- 100 %  $R_g$  and UIS Tested

#### **APPLICATIONS**

- Synchronous Rectification
- Power Supplies



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	<b>5</b> T <sub>A</sub> = 25 °C, unles	ss otherwise not	ed	
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V <sub>DS</sub>	40	V
Gate-Source Voltage	V <sub>GS</sub>	± 25	v	
	T <sub>C</sub> = 25 °C		280	
Continuous Drain Current ( $T_1 = 175 \ ^{\circ}C$ )	T <sub>C</sub> = 70 °C		220	
Continuous Diain Current (1) = 175 C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	229 <sup>b</sup>	A
	T <sub>A</sub> = 70 °C		223 <sup>b</sup>	
Pulsed Drain Current		I <sub>DM</sub>	750	
Avalanche Current Pulse	L = 0.1 mH	I <sub>AS</sub>	80	
Single Pulse Avalanche Energy		E <sub>AS</sub>	320	V
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	I <sub>S</sub>	110 <sup>a, c</sup>	A
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	'5	2.6 <sup>b</sup>	~
	T <sub>C</sub> = 25 °C		312 <sup>a</sup>	
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	PD	200	w
	T <sub>A</sub> = 25 °C	۲D –	3.13 <sup>b</sup>	
	T <sub>A</sub> = 70 °C		2.0 <sup>b</sup>	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b</sup>	Steady State	R <sub>thJA</sub>	32	40	°C/W	
Maximum Junction-to-Case	Steady State	R <sub>thJC</sub>	0.33	0.4	0/10	

Notes:

a. Based on T<sub>C</sub> = 25 °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. Calculated based on maximum junction temperature. Package limitation current is 110 A.

<b>SPECIFICATIONS</b> $T_J = 25 \text{ °C}, u$	uniess otner	wise noted		T		1	
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static			-		-	•	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	45			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 250 μA		41		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			- 8			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.2		2.5	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA	
		$V_{DS}$ = 40 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C			10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 V$ , $V_{GS} = 10 V$	120			Α	
Drain-Source On-State Resistance <sup>a</sup>	Provide	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 30 A		0.0010			
	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 20 A		0.0012		Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 30 A		180		S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			9335		pF	
Output Capacitance	C <sub>oss</sub>	$V_{DS}$ = 20 V, $V_{GS}$ = 0 V, f = 1 MHz		1150			
Reverse Transfer Capacitance	C <sub>rss</sub>			850			
Total Gate Charge	Qg			160	260	nC	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 20$ V, $V_{GS} = 10$ V, $I_{D} = 20$ A		40			
Gate-Drain Charge	Q <sub>gd</sub>			22			
Gate Resistance	Rg	f = 1 MHz		0.85	1.3	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			20	30		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 20 V, $R_L$ = 1.0 $\Omega$		11	17	- ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ 20 A, $V_{GEN}$ = 10 V, $R_g$ = 1 $\Omega$		77	115		
Fall Time	t <sub>f</sub>			10	15		
Turn-On Delay Time	t <sub>d(on)</sub>			102	155		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 20 V, $R_L$ = 1.0 $\Omega$		62	95		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 20$ Å, $V_{GEN}$ = 4.5 V, $R_g$ = 1 $\Omega$		180	270		
Fall Time	t <sub>f</sub>			60	90		
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			110	A	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				200		
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 20 A		0.8	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			50	75	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	L = 20.4  di/dt = 100.4/ma  T = 25.90		70	105	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	I <sub>F</sub> = 20 A, di/dt = 100 A/μs, T <sub>J</sub> = 25 °C		30			
Reverse Recovery Rise Time				20		ns	

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

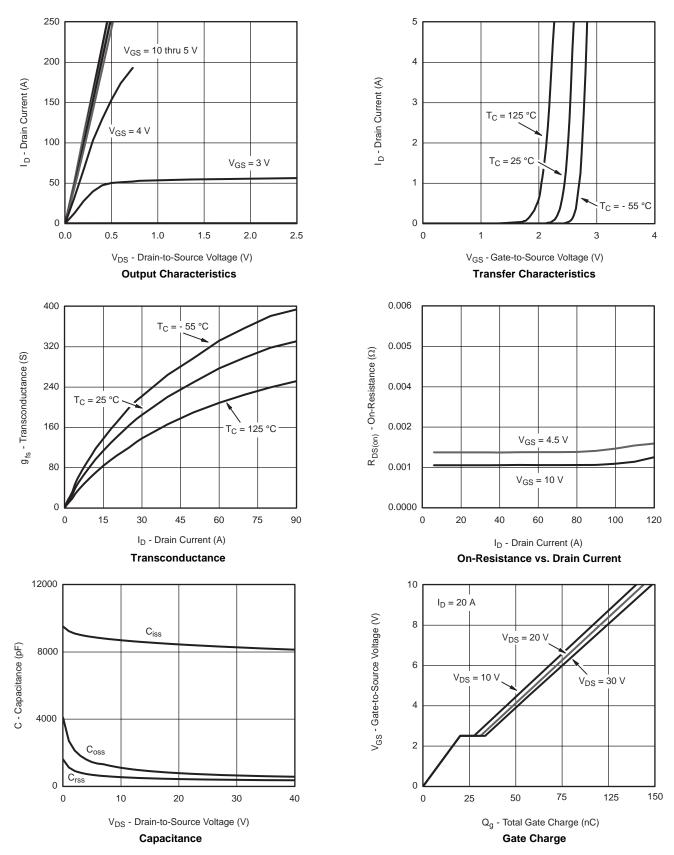
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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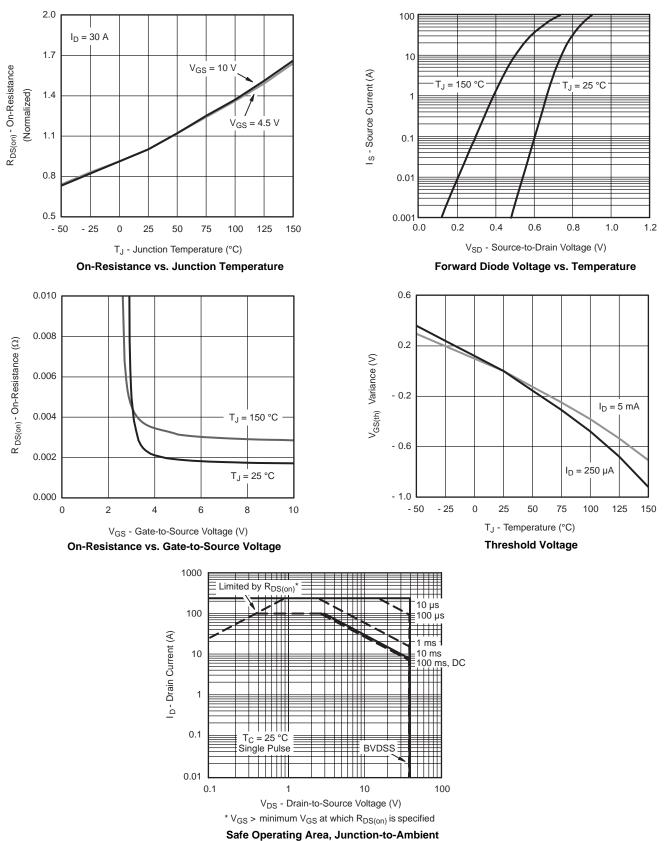
### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



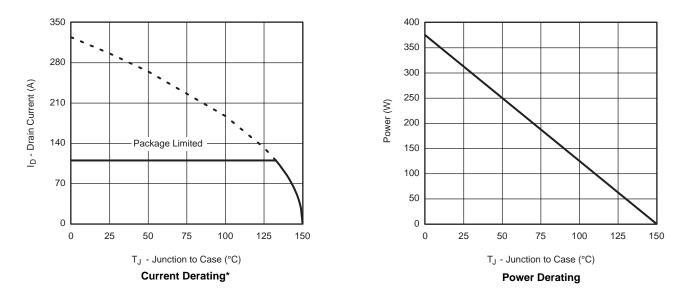
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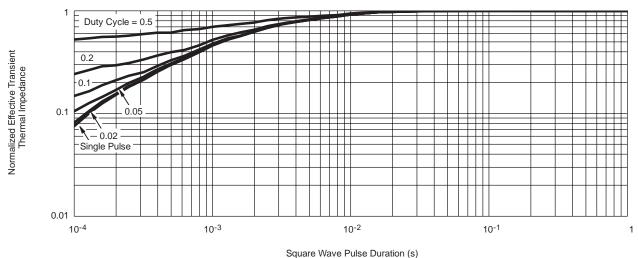






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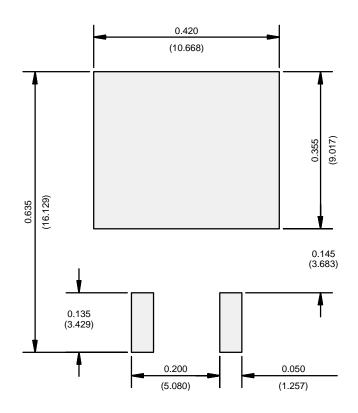
\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



Normalized Thermal Transient Impedance, Junction-to-Case



### **RECOMMENDED MINIMUM PADS FOR D<sup>2</sup>PAK: 3-Lead**



Recommended Minimum Pads Dimensions in Inches/(mm)



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